

DEVELOPMENT DATA

This data sheet contains advance information and specifications are subject to change without notice.

PBYR40035CT
PBYR40040CT
PBYR40045CT

SCHOTTKY – BARRIER DOUBLE RECTIFIER DIODES

Low-leakage platinum-barrier double rectifier diodes in TO-244 envelopes, featuring low forward voltage drop, low capacitance, and absence of stored charge. They are intended for use in switched-mode power supplies and high-frequency circuits in general, where both low conduction losses and zero switching losses are important.

They can withstand reverse voltage transients and have guaranteed reverse avalanche surge capability. The series consists of common-cathode types.

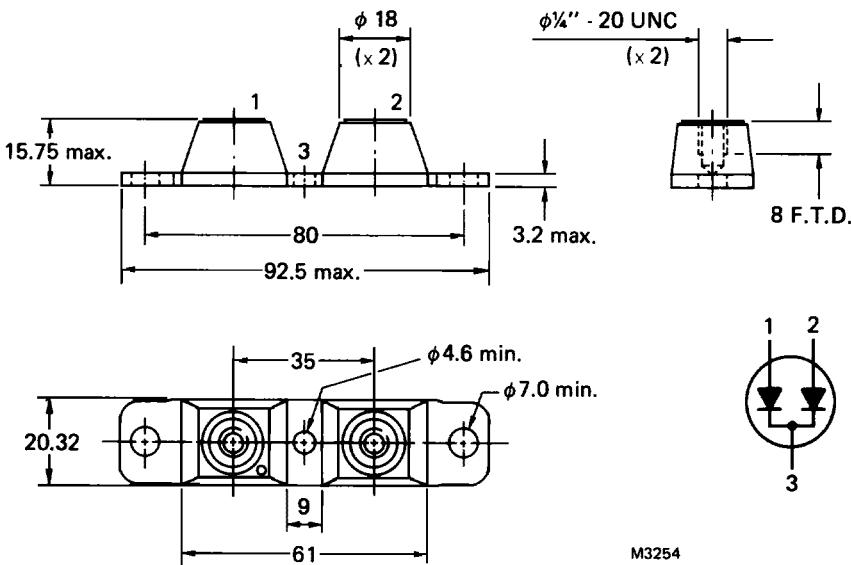
QUICK REFERENCE DATA

	V _{RRM}	max.	PBYR40035	40	45 CT	
Repetitive peak reverse voltage	V _{RRM}	max.	35	40	45	V
Output current (both diodes conducting)	I _O	max.		400		A
Forward voltage	V _F	typ.		0.58		V
Junction temperature	T _j	max.		150		°C

MECHANICAL DATA

Dimensions in mm

Fig.1 TO-244.



Net mass: 73 g.

Terminal penetration: 7.0 mm max.
Terminal torque: 29 – 46 kg cm
25 – 40 lb in
Mounting base torque: 35 – 46 kg cm
30 – 40 lb in

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134).

Voltages (per diode)		PBYR40035	40	45 CT	
Repetitive peak reverse voltage	V_{RRM}	max.	35	40	V
Crest working reverse voltage	V_{RWM}	max.	35	40	V
Continuous reverse voltage	V_R	max.	35	40	V
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Currents					
Average forward current squarewave; $\delta = 0.5$; up to $T_{mb} = 85^\circ\text{C}$ (note 1)					
per diode	$I_{F(AV)}$	max.	200		A
per device	I_O	max.	400		A
Repetitive peak forward current per diode (note 1) $t_p = 20 \mu\text{s}; \delta = 0.02$	I_{FRM}	max.	3000		A
Non-repetitive peak forward current half sinewave; $T_j = 125^\circ\text{C}$ prior to surge; with reapplied V_{RWM} max					
$t = 8.3 \text{ ms}$	I_{FSM}	max.	3000		A
$t = 10 \text{ ms}$	I_{FSM}	max.	2500		A
I^2t for fusing ($t = 10 \text{ ms}$; per device)	I^2t	max.	31250		A^2s
Reverse surge current (per diode) $t_p = 2 \mu\text{s}; \delta = 0.001$	I_{RRM}	max.	2.0		A
$t_p = 100 \mu\text{s}$	I_{RSM}	max.	2.0		A
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Temperatures					
Storage temperature	T_{stg}		-65 to +175		$^\circ\text{C}$
Junction temperature	T_j	max.	150		$^\circ\text{C}$
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CHARACTERISTICS (per diode)					
Forward voltage (note 2)					
$I_F = 200 \text{ A}; T_j = 150^\circ\text{C}$	V_F	<	0.63		V
$I_F = 400 \text{ A}; T_j = 125^\circ\text{C}$	V_F	typ.	0.75		V
$I_F = 200 \text{ A}; T_j = 125^\circ\text{C}$	V_F	typ.	0.58		V
$I_F = 200 \text{ A}; T_j = 25^\circ\text{C}$	V_F	<	0.69		V
Reverse current					
$V_R = V_{RWM}$ max; $T_j = 125^\circ\text{C}$	I_R	<	400		mA
$V_R = V_{RWM}$ max; $T_j = 25^\circ\text{C}$	I_R	<	4.0		mA
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THERMAL RESISTANCE					
Junction to mounting-base (per diode)	$R_{th j-mb}$	<	0.4		K/W

Notes:

- Assuming no reverse leakage losses.
- Measured under pulse conditions to avoid excessive dissipation.

SQUAREWAVE OPERATION (Figs.3 and 4)

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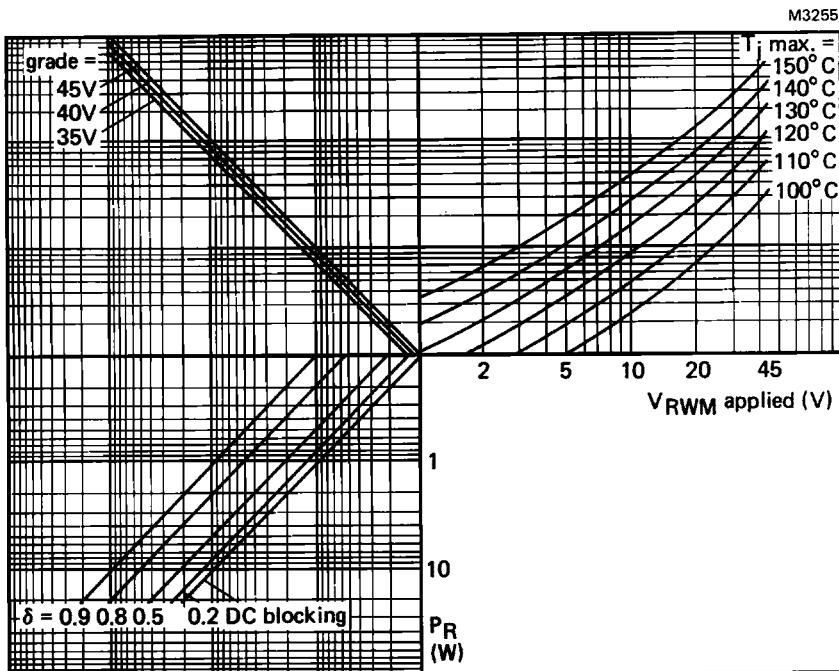


Fig.3 NOMOGRAM: for calculation of P_R (reverse leakage power dissipation) for a given T_j max., V_{RWM} applied, voltage grade and duty cycle; per diode.

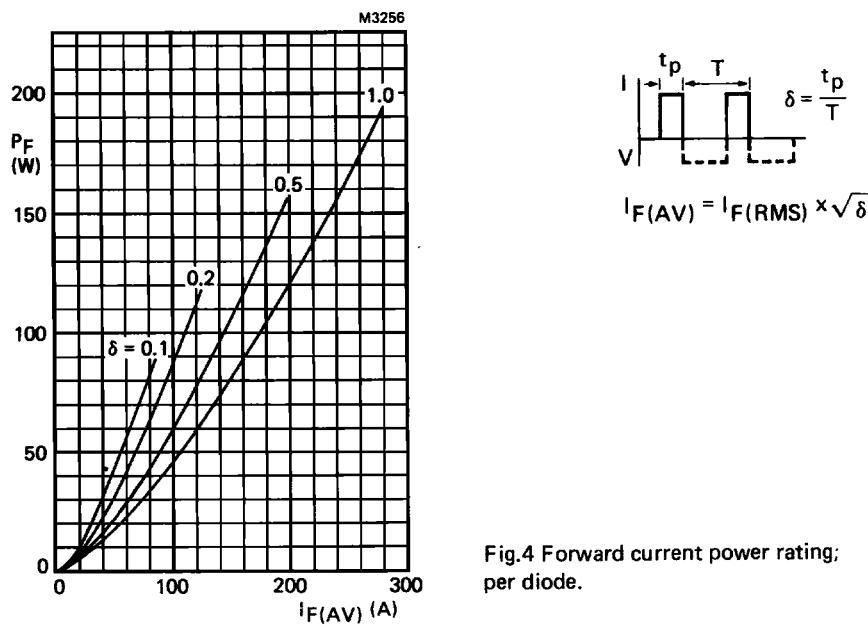


Fig.4 Forward current power rating; per diode.

SINUSOIDAL OPERATION (Figs.5 and 6)

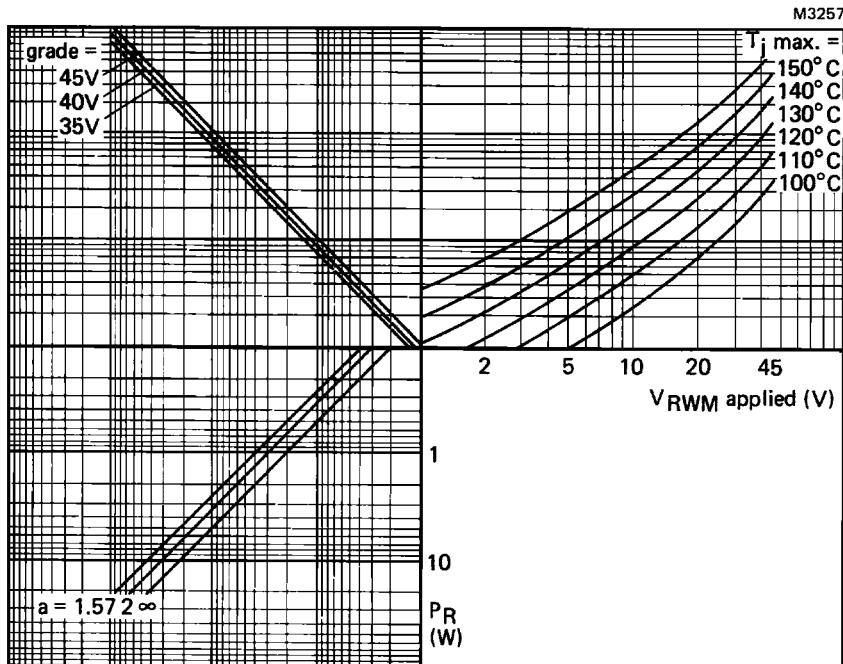


Fig.5 NOMOGRAM: for calculation of P_R (reverse leakage power dissipation) for a given T_j max., V_{RWM} applied, voltage grade and form factor; per diode.
 a = form factor = $I_F(RMS)/I_F(AV)$.

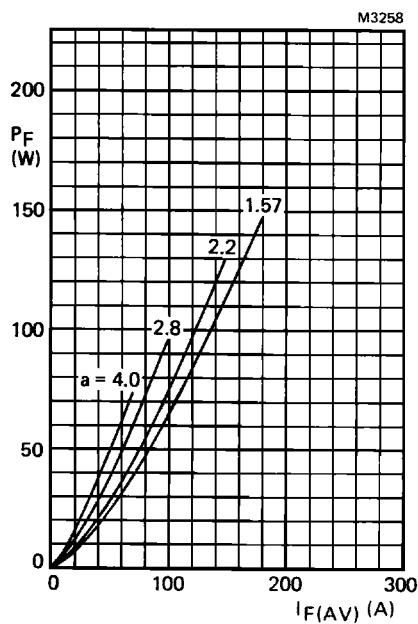


Fig.6 Forward current power rating;
 per diode.

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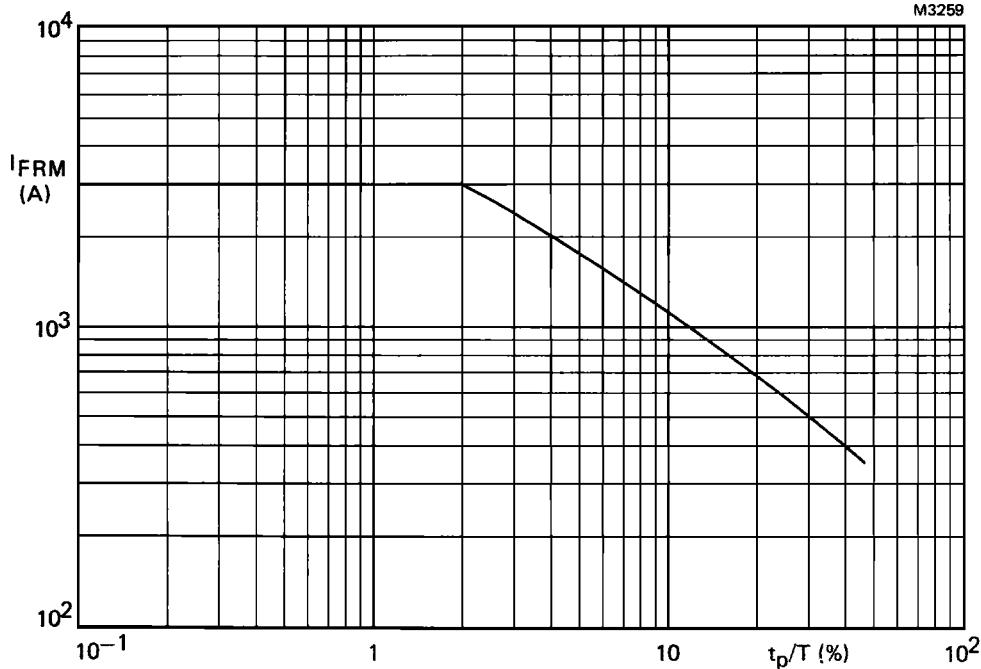


Fig.7 Maximum permissible repetitive peak forward current for either square or sinusoidal current for $1\text{ }\mu\text{s} < t_p < 1\text{ ms}$; per diode.

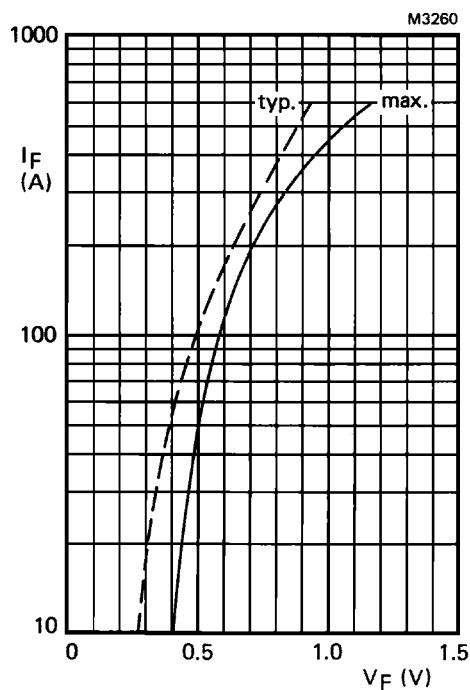
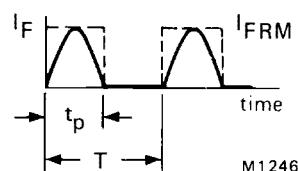


Fig.8 Forward voltage; per diode;
— $T_j = 25^\circ\text{C}$; - - $T_j = 125^\circ\text{C}$.



Definition of I_{FRM} and t_p/T .

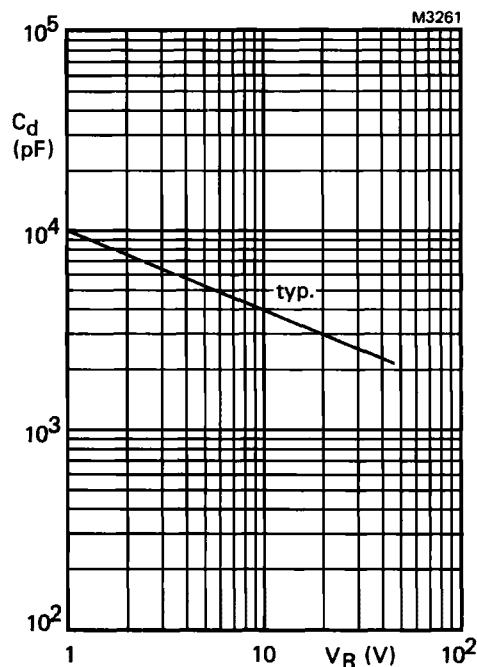


Fig.9 $f = 1$ MHz; $T_j = 25$ to 125 °C;
 per diode.

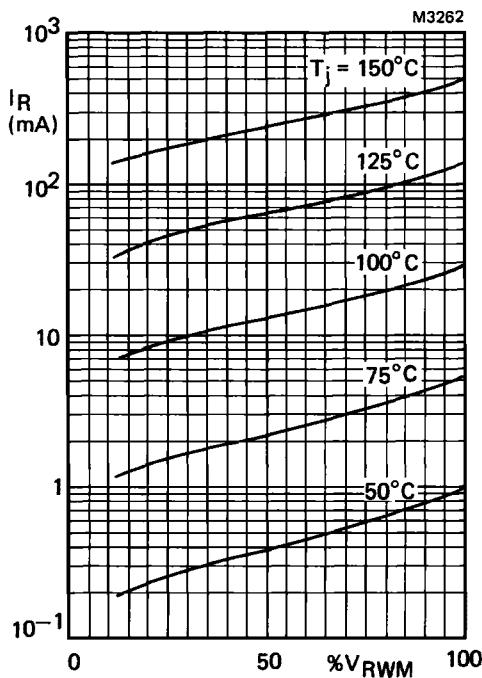


Fig.10 Typical values; per diode.